

CX9SM AT CRYSTAL 13.5 MHz to 250 MHz

Ultra-Miniature Surface Mount AT Quartz Crystal

## DESCRIPTION

Designed and manufactured in the USA, Statek's CX9SM AT quartz crystal is the newest device available in frequencies ranging from 13.5 MHz to 250 MHz. This device has been specifically designed for applications requiring a very small foot print and low profile. It is 4.1 mm x 1.5 mm with a height under 1 mm. Using micro-machining processes, this surface-mountable crystal is hermetically sealed within an ultra-miniature ceramic package to ensure high stability and low aging. Tight calibration and excellent frequency/temperature stability make the CX9SM ideally suited for many high frequency applications.

### FEATURES

- Low profile (less than 1 mm)
- High shock and vibration survival
- Ultra-miniature, surface mount design
- Available with glass or ceramic lid
- Hermetically sealed ceramic package
- Excellent aging characteristics
- Designed for low power applications
- Full military testing available
- Designed, manufactured and tested in the USA

# APPLICATIONS

## Medical

- Medical RF Telemetry
- Cardiac Rhythm Management
- Cochlear Implants
- Infusion Pump

## Industrial & Communications

- Down-hole Data Recorder
- Process Control
- Environmental Control
- Telemetry
- Ruggedized Instrumentation

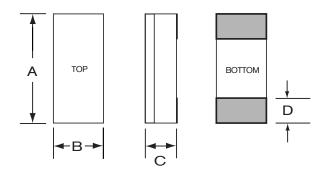
### Military & Aerospace

- Smart Munitions
- Missile Telemetry
- Ruggedized Communications
- Aviation Equipment



ceramic lid

### PACKAGE DIMENSIONS



TYPICAL		MAXIMUM	
inches	mm	inches	mm
0.160	4.10	0.170	4.32
0.060	1.50	0.068	1.73
-	-	see below	
0.031	0.79	0.038	0.97
	inches 0.160 0.060 -	inches mm   0.160 4.10   0.060 1.50   - -	inches mm inches   0.160 4.10 0.170   0.060 1.50 0.068   - - see b

#### THICKNESS (DIM C) MAXIMUM

CERAMIC		GLASS	
inches	mm	inches	mm
0.035	0.90	0.034	0.87
0.035	0.90	0.034	0.87
0.037	0.94	0.036	0.91
	inches 0.035 0.035	inches mm 0.035 0.90 0.035 0.90	inches mm inches   0.035 0.90 0.034   0.035 0.90 0.034



#### SPECIFICATIONS

Specifications are typical at 25°C unless otherwise noted. Specifications are subject to change without notice.

Fundamental Frequency	14.7456 MHz	<u>24 MHz</u>	<u>49 MHz</u>
Motional Resistance $R_1(\Omega)$	65	30	30
Motional Capacitance $C_1$ (fF)	1.2	1.6	2.1
Quality Factor Q (k)	140	150	60
Shunt Capacitance C <sub>0</sub> (pF)	0.6	0.8	1.0
Calibration Tolerance <sup>1</sup>	± 100 ppm, or	tighter as	required
Load Capacitance	10 pF (unless sp	ecified otherv	vise)
Drive Level	200 µW MAX	for $f \le 50$	) MHz
	100 μW MAX	for $f > 50$	) MHz
Frequency-Temperature Stability <sup>1,3</sup>	± 50 ppm to	± 10 ppm	(Commercial)
	$\pm$ 100 ppm to $\pm$ 20 ppm (Industrial)		
	$\pm$ 100 ppm to $\pm$ 30 ppm (Military)		
Aging, first year <sup>3</sup>	5 ppm MAX (t	petter than 1	ppm available)
Shock, survival	100,000 g, 0	.3 ms, 1/2	2 sine
Vibration, survival <sup>4</sup>	20 g, 10-2,00	00 Hz swe	pt sine
Operating Temp. Range	-10°C to +70 -40°C to +85 -55°C to +12	°C (Indus	trial)
Storage Temp. Range	-55°C to +12	5°C	
Max Process Temperature	260°C for 20	sec.	

2. Does not include calibration tolerance. The characteristics of the frequency stability over

3. 5 ppm MAX for frequencies below 40 MHz. For tighter tolerances and higher frequencies

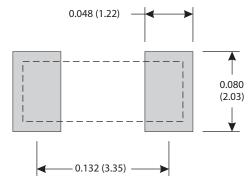
4. Per MIL-STD-202G, Method 204D, Condition D. Random vibration testing also available.

TERMINATIONS

<u>Termination</u>
Gold Plated
Solder Plated
Solder Dipped
Solder Plated (Lead Free)
Solder Dipped (Lead Free)

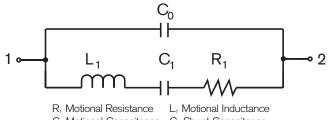
Max Process Temperature 260°C for 20 sec.

# SUGGESTED LAND PATTERN



inches (mm)

## EQUIVALENT CIRCUIT



C<sub>1</sub> Motional Capacitance C<sub>0</sub> Shunt Capacitance

## PACKAGING OPTIONS

- Tray Pack
- 16mm tape, 7" or 13" reels Per EIA 481 (see Tape and Reel data sheet 10109)

1. Other tolerances available. Contact factory.

contact factory.

temperature follow that of the AT thickness-shear mode.

